ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	annockburn, Illinois. A	ll rights reserved un ntions.	nder both leve	is docume el parts, th	ent is a declaratio he declaration en	n of the substance compasses all lov	es within the manufactur ver level materials for w	er listed iter hich the mar	n. Note: if nufacturer h	the item is an as has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mf					Informatio	on		
Supplier Information												
Company name* Company unique ID			Unique ID			ID Authority			Response Date*			
isemi									2023-06-08			
Contact Name	Title - Contact			I	Phone - Contact*			Email - Contact*				
Product-Env-Stewards	duct-Env-Stewards Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compli			Compliance		NA			Product-Env-Stewards@onsemi.com				
Requester Item Number N	Afr Item Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		eight*	UOM	Unit Type	
N	CV305LSQ20T1G	V305LSQ20T1G Voltage Detect Ser			2023-06-08	6-08 MY1		7.2	22	mg	Each	
Manufacturing Proccess Information							·					
Terminal Plating / Grid Array Material	inal Plating / Grid Array Material Terminal Base Alloy J		-STD-020 MSL Ra	ating	Peak Proces	ss Body Temperat	ture Max Time at Peak	Temperatur	e Numbe	er of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy 1					260	С	30	seconds	3			
Comments												
evel 1 - maximum time at peak temperature du	ring soldering is 10-3	0 seconds										
for more information regarding material comp	osition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, admium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best its form. Supplier acknowledges that Company will rely on this certification in determining the complicace of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others, Supplier shas not independently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the ireffication in this paragraph. If the Company and the Supplier rinto a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of hat agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.13	mg	Supplier	Silicon (Si)	7440-21-3		0.13	mg
Die Attach	0.08	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.0256	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0534	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.001	mg
Lead Frame	1.31	mg	Supplier	Zinc (Zn)	7440-66-6		0.0013	mg
			Supplier	Iron (Fe)	7439-89-6		0.0301	mg
			Supplier	Copper (Cu)	7440-50-8		1.2772	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0013	mg
Mold Compound-Black	4.49	mg		Epoxy resin	proprietary data		0.211	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.449	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0045	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.6144	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.211	mg
Plating	1.19	mg	Supplier	Tin (Sn)	7440-31-5		1.19	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).